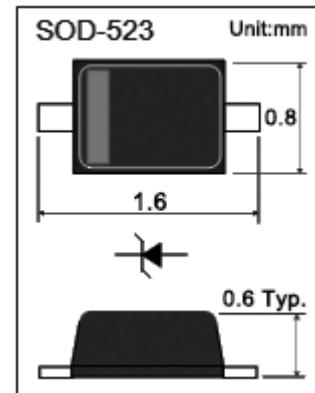


- ◇ Fast switching devices
- ◇ SOD523 Micro SMD package
- ◇ RoHS compliant / Green EMC
- ◇ Matte Tin (Sn) Lead finish
- ◇ Cathode Band / Device marking
- ◇ Surface Mount Package Ideally Suited for Automatic Insertion
- ◇ For General Purpose Switching Applications
- ◇ High Conductance



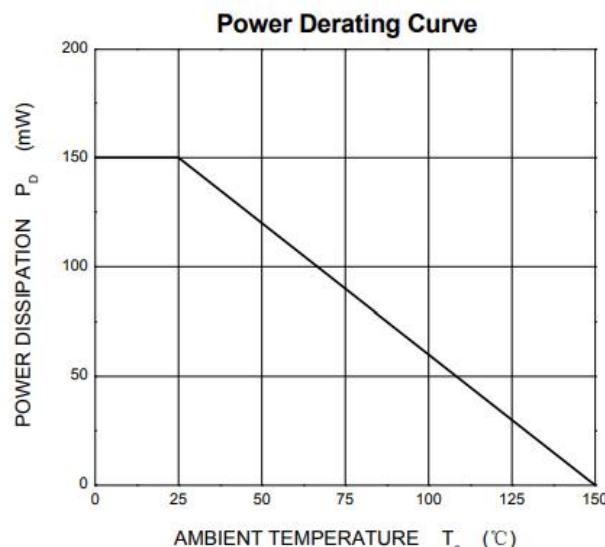
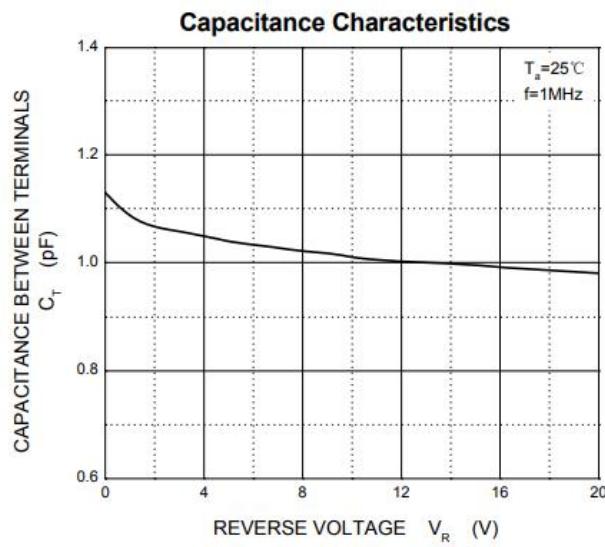
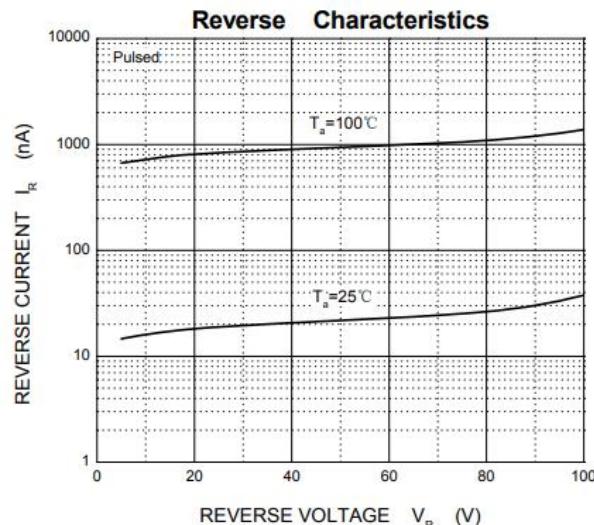
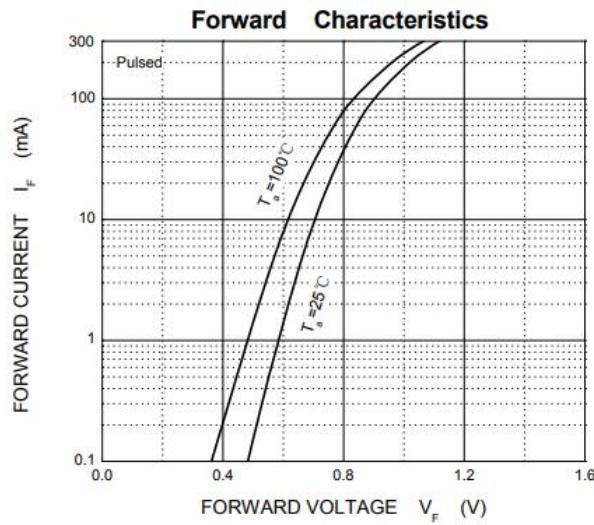
Maximum Ratings (Ta = 25 °C)

Symbol	Parameter	Value	Units
V _{RM}	Non-Repetitive Peak Reverse Voltage	100	V
V _{RRM}	Repetitive Peak Reverse Voltage	100	V
V _{R(RMS)}	RMS Reverse Voltage	75	V
I _{FM}	Forward Continuous Current	300	mA
I _O	Average Rectified Output Current	150	mA
I _{FSM}	Non-Repetitive Peak Forward Surge Current (@t=8..3ms)	2.0	A
P _D	Power Dissipation	150	mW
T _J	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-55 to +150	°C

Electrical Characteristics (Ta = 25 °C)

Symbol	Parameter	Conditions	Min	Max	Units
V _F	Forward Voltage	I _F = 1mA	0.715		V
		I _F = 10mA	0.855		V
		I _F = 50mA	1.0		V
		I _F = 150mA	1.25		V
I _R	Reverse current	V _R = 75V (25°C)		1	μA
		V _R = 20V (25°C)		25	nA
		V _R = 75V (150°C)		50	μA
C _T	Capacitance	V _R = 0V, f = 1MHz		2	pF
t _{rr}	Reverse Recovery Time	I _F = I _R = 10mA, I _{RR} = 1mA, R _L = 100Ω		4	ns

Typical Characteristics



Package Dimensions

